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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | RL78 |
| Core Size | 16-Bit |
| Speed | 32MHz |
| Connectivity | CSI, I ² C, LINbus, UART/USART |
| Peripherals | DMA, LVD, POR, PWM, WDT |
| Number of I/O | 31 |
| Program Memory Size | 16KB (16K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 2K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V |
| Data Converters | A/D 10x8/10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 44-LQFP |
| Supplier Device Package | 44-LQFP (10x10) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101fadfp-30 |

Table 1-1. List of Ordering Part Numbers

(4/12)

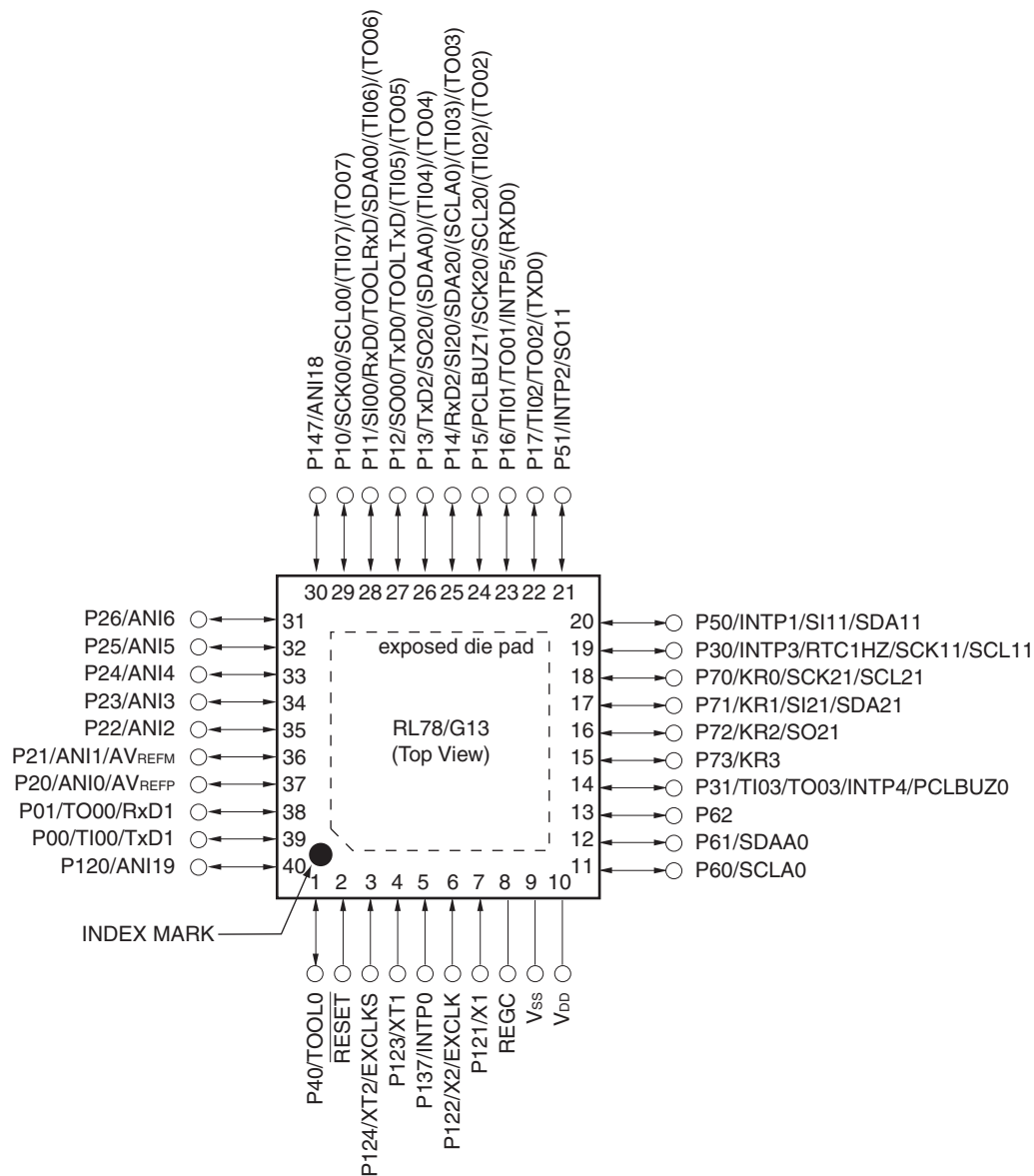
| Pin count | Package | Data flash | Fields of Application Note | Ordering Part Number |
|-----------|---|-------------|-------------------------------|--|
| 44 pins | 44-pin plastic LQFP (10 × 10 mm, 0.8 mm pitch) | Mounted | A | R5F100FAAFP#V0, R5F100FCAFP#V0, R5F100FDAFP#V0, R5F100FEAFP#V0, R5F100FFAFP#V0, R5F100FGAFP#V0, R5F100FHAFP#V0, R5F100FJAFP#V0, R5F100FKAFP#V0, R5F100FLAFP#V0 R5F100FAAFP#X0, R5F100FCAFP#X0, R5F100FDAFP#X0, R5F100FEAFP#X0, R5F100FFAFP#X0, R5F100FGAFP#X0, R5F100FHAFP#X0, R5F100FJAFP#X0, R5F100FKAFP#X0, R5F100FLAFP#X0 |
| | | | D | R5F100FADFP#V0, R5F100FCDFP#V0, R5F100FDDFP#V0, R5F100FEDFP#V0, R5F100FFDFP#V0, R5F100FGDFP#V0, R5F100FHDFP#V0, R5F100FJDFP#V0, R5F100FKDFP#V0, R5F100FLDFP#V0 R5F100FADFP#X0, R5F100FCDFP#X0, R5F100FDDFP#X0, R5F100FEDFP#X0, R5F100FFDFP#X0, R5F100FGDFP#X0, R5F100FHDFP#X0, R5F100FJDFP#X0, R5F100FKDFP#X0, R5F100FLDFP#X0 |
| | | | G | R5F100FAGFP#V0, R5F100FCGFP#V0, R5F100FDGFP#V0, R5F100FEGFP#V0, R5F100FFGFP#V0, R5F100FGGFP#V0, R5F100FHGFP#V0, R5F100FJGFP#V0 R5F100FAGFP#X0, R5F100FCGFP#X0, R5F100FDGFP#X0, R5F100FEGFP#X0, R5F100FFGFP#X0, R5F100FGGFP#X0, R5F100FHGFP#X0, R5F100FJGFP#X0 |
| | | Not mounted | A | R5F101FAAFP#V0, R5F101FCAFP#V0, R5F101FDAFP#V0, R5F101FEAFP#V0, R5F101FFAFP#V0, R5F101FGAFP#V0, R5F101FHAFP#V0, R5F101FJAFP#V0, R5F101FKAFP#V0, R5F101FLAFP#V0 R5F101FAAFP#X0, R5F101FCAFP#X0, R5F101FDAFP#X0, R5F101FEAFP#X0, R5F101FFAFP#X0, R5F101FGAFP#X0, R5F101FHAFP#X0, R5F101FJAFP#X0, R5F101FKAFP#X0, R5F101FLAFP#X0 |
| | | | D | R5F101FADFP#V0, R5F101FCDFP#V0, R5F101FDDFP#V0, R5F101FEDFP#V0, R5F101FFDFP#V0, R5F101FGDFP#V0, R5F101FHDFP#V0, R5F101FJDFP#V0, R5F101FKDFP#V0, R5F101FLDFP#V0 R5F101FADFP#X0, R5F101FCDFP#X0, R5F101FDDFP#X0, R5F101FEDFP#X0, R5F101FFDFP#X0, R5F101FGDFP#X0, R5F101FHDFP#X0, R5F101FJDFP#X0, R5F101FKDFP#X0, R5F101FLDFP#X0 |

Note For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.

1.3.7 40-pin products

- 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)



Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 μ F).

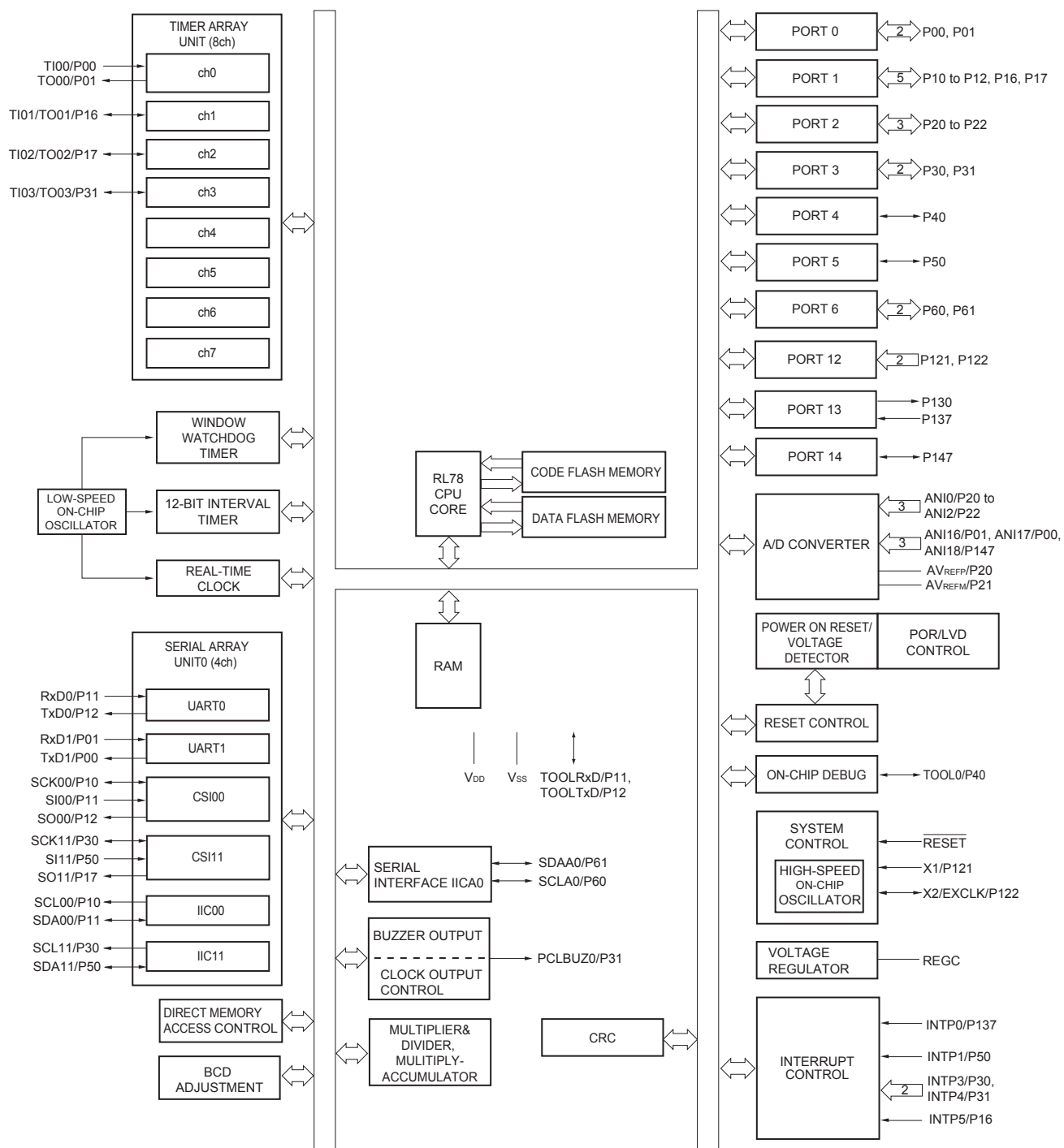
Remarks 1. For pin identification, see 1.4 Pin Identification.

- Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.
- It is recommended to connect an exposed die pad to Vss.

1.4 Pin Identification

| | | | |
|---|--|--|--|
| ANI0 to ANI14, | | REGC: | Regulator capacitance |
| ANI16 to ANI26: | Analog input | RESET: | Reset |
| AV _{REFM} : | A/D converter reference potential (– side) input | RTC1HZ: | Real-time clock correction clock (1 Hz) output |
| AV _{REFP} : | A/D converter reference potential (+ side) input | RxD0 to RxD3: | Receive data |
| EV _{DD0} , EV _{DD1} : | Power supply for port | SCK00, SCK01, SCK10, SCK11, SCK20, SCK21, | |
| EV _{SS0} , EV _{SS1} : | Ground for port | SCLA0, SCLA1: | Serial clock input/output |
| EXCLK: | External clock input (Main system clock) | SCLA0, SCLA1, SCL00, SCL01, SCL10, SCL11, | |
| EXCLKS: | External clock input (Subsystem clock) | SCL20, SCL21, SCL30, SCL31: | Serial clock output |
| INTP0 to INTP11: | Interrupt request from peripheral | SDAA0, SDAA1, SDA00, SDA01, SDA10, SDA11, SDA20, SDA21, SDA30, | |
| KR0 to KR7: | Key return | SDA31: | Serial data input/output |
| P00 to P07: | Port 0 | SI00, SI01, SI10, SI11, | |
| P10 to P17: | Port 1 | SI20, SI21, SI30, SI31: | Serial data input |
| P20 to P27: | Port 2 | SO00, SO01, SO10, | |
| P30 to P37: | Port 3 | SO11, SO20, SO21, | |
| P40 to P47: | Port 4 | SO30, SO31: | Serial data output |
| P50 to P57: | Port 5 | TI00 to TI07, | |
| P60 to P67: | Port 6 | TI10 to TI17: | Timer input |
| P70 to P77: | Port 7 | TO00 to TO07, | |
| P80 to P87: | Port 8 | TO10 to TO17: | Timer output |
| P90 to P97: | Port 9 | TOOL0: | Data input/output for tool |
| P100 to P106: | Port 10 | TOOLRxD, TOOLTxD: | Data input/output for external device |
| P110 to P117: | Port 11 | TxD0 to TxD3: | Transmit data |
| P120 to P127: | Port 12 | V _{DD} : | Power supply |
| P130, P137: | Port 13 | V _{SS} : | Ground |
| P140 to P147: | Port 14 | X1, X2: | Crystal oscillator (main system clock) |
| P150 to P156: | Port 15 | XT1, XT2: | Crystal oscillator (subsystem clock) |
| PCLBUZ0, PCLBUZ1: | Programmable clock output/buzzer output | | |

1.5.3 25-pin products



1.6 Outline of Functions

[20-pin, 24-pin, 25-pin, 30-pin, 32-pin, 36-pin products]

Caution This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.

(1/2)

| Item | | 20-pin | | 24-pin | | 25-pin | | 30-pin | | 32-pin | | 36-pin | |
|------------------------------------|---|---|--|--|--|--|---|--------------------------|----------|--------------------------|----------|--------------------------|----------|
| | | R5F1006x | R5F1016x | R5F1007x | R5F1017x | R5F1008x | R5F1018x | R5F100Ax | R5F101Ax | R5F100Bx | R5F101Bx | R5F100Cx | R5F101Cx |
| Code flash memory (KB) | | 16 to 64 | | 16 to 64 | | 16 to 64 | | 16 to 128 | | 16 to 128 | | 16 to 128 | |
| Data flash memory (KB) | | 4 | – | 4 | – | 4 | – | 4 to 8 | – | 4 to 8 | – | 4 to 8 | – |
| RAM (KB) | | 2 to 4 ^{Note1} | | 2 to 4 ^{Note1} | | 2 to 4 ^{Note1} | | 2 to 12 ^{Note1} | | 2 to 12 ^{Note1} | | 2 to 12 ^{Note1} | |
| Address space | | 1 MB | | | | | | | | | | | |
| Main system clock | High-speed system clock | X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (High-speed main) mode: 1 to 20 MHz (V _{DD} = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | | | | | | | | | | | |
| | High-speed on-chip oscillator | HS (High-speed main) mode: 1 to 32 MHz (V _{DD} = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | | | | | | | | | | | |
| Subsystem clock | | – | | | | | | | | | | | |
| Low-speed on-chip oscillator | | 15 kHz (TYP.) | | | | | | | | | | | |
| General-purpose registers | | (8-bit register × 8) × 4 banks | | | | | | | | | | | |
| Minimum instruction execution time | | 0.03125 μs (High-speed on-chip oscillator: f _{IH} = 32 MHz operation) | | | | | | | | | | | |
| | | 0.05 μs (High-speed system clock: f _{MX} = 20 MHz operation) | | | | | | | | | | | |
| Instruction set | | <ul style="list-style-type: none">• Data transfer (8/16 bits)• Adder and subtractor/logical operation (8/16 bits)• Multiplication (8 bits × 8 bits)• Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc. | | | | | | | | | | | |
| I/O port | Total | 16 | 20 | 21 | 26 | 28 | 32 | | | | | | |
| | CMOS I/O | 13 (N-ch O.D. I/O [V _{DD} withstand voltage]: 5) | 15 (N-ch O.D. I/O [V _{DD} withstand voltage]: 6) | 15 (N-ch O.D. I/O [V _{DD} withstand voltage]: 6) | 21 (N-ch O.D. I/O [V _{DD} withstand voltage]: 9) | 22 (N-ch O.D. I/O [V _{DD} withstand voltage]: 9) | 26 (N-ch O.D. I/O [V _{DD} withstand voltage]: 10) | | | | | | |
| | CMOS input | 3 | 3 | 3 | 3 | 3 | 3 | | | | | | |
| | CMOS output | – | – | 1 | – | – | – | | | | | | |
| | N-ch O.D. I/O (withstand voltage: 6 V) | – | 2 | 2 | 2 | 3 | 3 | | | | | | |
| Timer | 16-bit timer | 8 channels | | | | | | | | | | | |
| | Watchdog timer | 1 channel | | | | | | | | | | | |
| | Real-time clock (RTC) | 1 channel ^{Note 2} | | | | | | | | | | | |
| | 12-bit interval timer (IT) | 1 channel | | | | | | | | | | | |
| | Timer output | 3 channels (PWM outputs: 2 ^{Note 3}) | 4 channels (PWM outputs: 3 ^{Note 3}) | | | | 4 channels (PWM outputs: 3 ^{Note 3}), 8 channels (PWM outputs: 7 ^{Note 3}) ^{Note 4} | | | | | | |
| | RTC output | – | | | | | | | | | | | |

- Notes**
- The flash library uses RAM in self-programming and rewriting of the data flash memory. The target products and start address of the RAM areas used by the flash library are shown below.
R5F100xD, R5F101xD (x = 6 to 8, A to C): Start address FF300H
R5F100xE, R5F101xE (x = 6 to 8, A to C): Start address FEF00H
For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.
 - Only the constant-period interrupt function when the low-speed on-chip oscillator clock (f_{IL}) is selected

3. The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see **6.9.3 Operation as multiple PWM output function** in the RL78/G13 User's Manual).
4. When setting to PIOR = 1

(2/2)

| Item | 20-pin | | 24-pin | | 25-pin | | 30-pin | | 32-pin | | 36-pin | |
|---|---|----------|------------|----------|------------|----------|------------|----------|------------|----------|------------|----------|
| | R5F1006x | R5F1016x | R5F1007x | R5F1017x | R5F1008x | R5F1018x | R5F100Ax | R5F101Ax | R5F100Bx | R5F101Bx | R5F100Cx | R5F101Cx |
| Clock output/buzzer output | — | | 1 | | 1 | | 2 | | 2 | | 2 | |
| | • 2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (Main system clock: f _{MAIN} = 20 MHz operation) | | | | | | | | | | | |
| 8/10-bit resolution A/D converter | 6 channels | | 6 channels | | 6 channels | | 8 channels | | 8 channels | | 8 channels | |
| Serial interface | [20-pin, 24-pin, 25-pin products] • CSI: 1 channel/simplified I ² C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I ² C: 1 channel/UART: 1 channel [30-pin, 32-pin products] • CSI: 1 channel/simplified I ² C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I ² C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I ² C: 1 channel/UART (UART supporting LIN-bus): 1 channel [36-pin products] • CSI: 1 channel/simplified I ² C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I ² C: 1 channel/UART: 1 channel • CSI: 2 channels/simplified I ² C: 2 channels/UART (UART supporting LIN-bus): 1 channel | | | | | | | | | | | |
| | I ² C bus | — | 1 channel | | 1 channel | | 1 channel | | 1 channel | | 1 channel | |
| Multiplier and divider/multiply-accumulator | • 16 bits × 16 bits = 32 bits (Unsigned or signed) • 32 bits ÷ 32 bits = 32 bits (Unsigned) • 16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed) | | | | | | | | | | | |
| DMA controller | 2 channels | | | | | | | | | | | |
| Vectored interrupt sources | Internal | 23 | 24 | | 24 | | 27 | | 27 | | 27 | |
| | External | 3 | 5 | | 5 | | 6 | | 6 | | 6 | |
| Key interrupt | — | | | | | | | | | | | |
| Reset | • Reset by $\overline{\text{RESET}}$ pin • Internal reset by watchdog timer • Internal reset by power-on-reset • Internal reset by voltage detector • Internal reset by illegal instruction execution ^{Note} • Internal reset by RAM parity error • Internal reset by illegal-memory access | | | | | | | | | | | |
| Power-on-reset circuit | • Power-on-reset: 1.51 V (TYP.) • Power-down-reset: 1.50 V (TYP.) | | | | | | | | | | | |
| Voltage detector | • Rising edge : 1.67 V to 4.06 V (14 stages) • Falling edge : 1.63 V to 3.98 V (14 stages) | | | | | | | | | | | |
| On-chip debug function | Provided | | | | | | | | | | | |
| Power supply voltage | V _{DD} = 1.6 to 5.5 V (T _A = -40 to +85°C) V _{DD} = 2.4 to 5.5 V (T _A = -40 to +105°C) | | | | | | | | | | | |
| Operating ambient temperature | T _A = 40 to +85°C (A: Consumer applications, D: Industrial applications) T _A = 40 to +105°C (G: Industrial applications) | | | | | | | | | | | |

Note The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

2.3 DC Characteristics

2.3.1 Pin characteristics

(T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V) (1/5)

| Items | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|--|------------------|--|-----------------------------------|------|--------------------------|------|
| Output current, high ^{Note 1} | I _{OH1} | Per pin for P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147 | 1.6 V ≤ EV _{DD0} ≤ 5.5 V | | -10.0 ^{Note 2} | mA |
| | | Total of P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145 (When duty ≤ 70% ^{Note 3}) | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | | -55.0 | mA |
| | | | 2.7 V ≤ EV _{DD0} < 4.0 V | | -10.0 | mA |
| | | | 1.8 V ≤ EV _{DD0} < 2.7 V | | -5.0 | mA |
| | | | 1.6 V ≤ EV _{DD0} < 1.8 V | | -2.5 | mA |
| | | Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147 (When duty ≤ 70% ^{Note 3}) | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | | -80.0 | mA |
| | | | 2.7 V ≤ EV _{DD0} < 4.0 V | | -19.0 | mA |
| | | | 1.8 V ≤ EV _{DD0} < 2.7 V | | -10.0 | mA |
| | | | 1.6 V ≤ EV _{DD0} < 1.8 V | | -5.0 | mA |
| | | Total of all pins (When duty ≤ 70% ^{Note 3}) | 1.6 V ≤ EV _{DD0} ≤ 5.5 V | | -135.0 ^{Note 4} | mA |
| | I _{OH2} | Per pin for P20 to P27, P150 to P156 | 1.6 V ≤ V _{DD} ≤ 5.5 V | | -0.1 ^{Note 2} | mA |
| | | Total of all pins (When duty ≤ 70% ^{Note 3}) | 1.6 V ≤ V _{DD} ≤ 5.5 V | | -1.5 | mA |

Notes 1. Value of current at which the device operation is guaranteed even if the current flows from the EV_{DD0}, EV_{DD1}, V_{DD} pins to an output pin.

2. However, do not exceed the total current value.

3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (I_{OH} × 0.7)/(n × 0.01)

<Example> Where n = 80% and I_{OH} = -10.0 mA

$$\text{Total output current of pins} = (-10.0 \times 0.7)/(80 \times 0.01) \cong -8.7 \text{ mA}$$

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

4. The applied current for the products for industrial application (R5F100xxDxx, R5F101xxDxx, R5F100xxGxx) is -100 mA.

Caution P00, P02 to P04, P10 to P15, P17, P43 to P45, P50, P52 to P55, P71, P74, P80 to P82, P96, and P142 to P144 do not output high level in N-ch open-drain mode.

Remark Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Notes**
1. Total current flowing into V_{DD} and EV_{DD0}, including the input leakage current flowing when the level of the input pin is fixed to V_{DD}, EV_{DD0} or V_{SS}, EV_{SS0}. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
 2. During HALT instruction execution by flash memory.
 3. When high-speed on-chip oscillator and subsystem clock are stopped.
 4. When high-speed system clock and subsystem clock are stopped.
 5. When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
 - HS (high-speed main) mode: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ @ 1 MHz to 32 MHz
 - $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ @ 1 MHz to 16 MHz
 - LS (low-speed main) mode: $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ @ 1 MHz to 8 MHz
 - LV (low-voltage main) mode: $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ @ 1 MHz to 4 MHz
 8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.

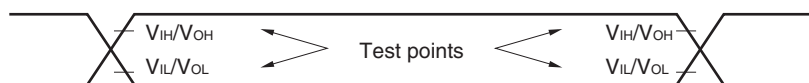
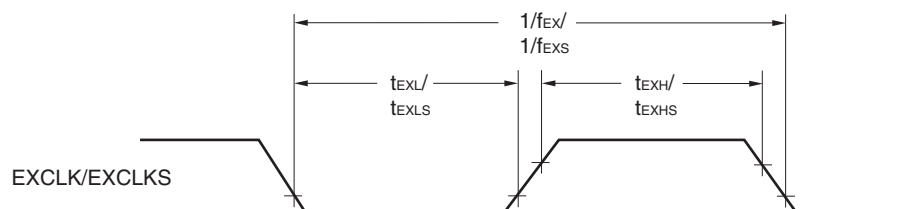
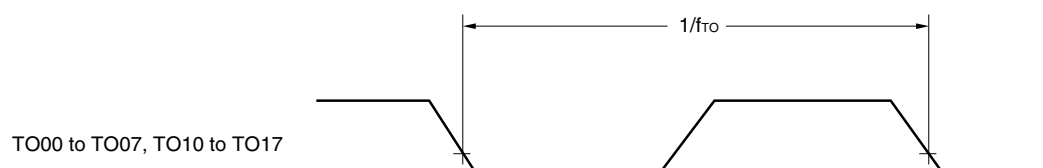
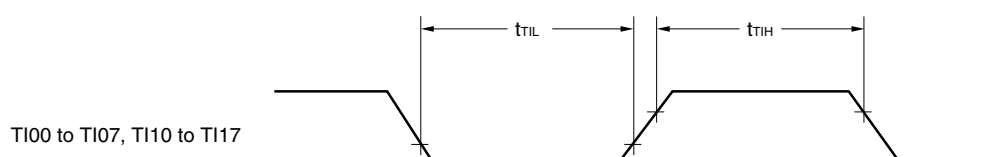
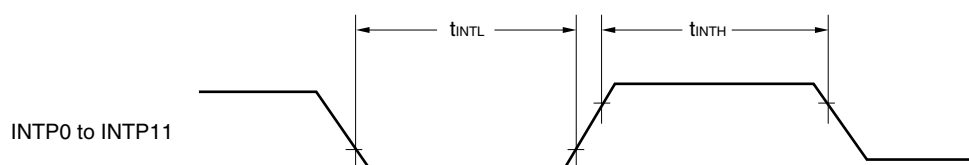
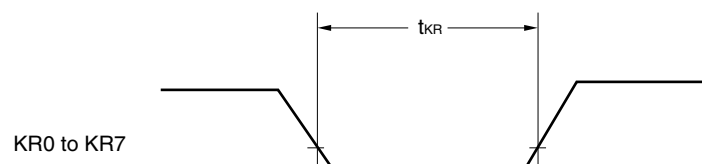
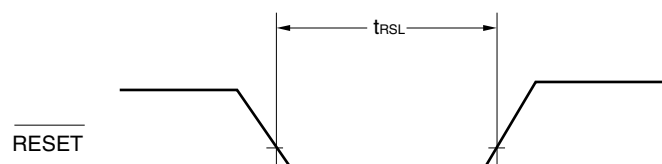
- Remarks**
1. f_{MX}: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
 2. f_{IH}: High-speed on-chip oscillator clock frequency
 3. f_{SUB}: Subsystem clock frequency (XT1 clock oscillation frequency)
 4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is T_A = 25°C

(4) Peripheral Functions (Common to all products)**(T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)**

| Parameter | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|--|---|----------------------------------|---|------|------|-------|------|
| Low-speed on-chip oscillator operating current | I _{FIL} ^{Note 1} | | | | 0.20 | | μA |
| RTC operating current | I _{RTC} ^{Notes 1, 2, 3} | | | | 0.02 | | μA |
| 12-bit interval timer operating current | I _{IT} ^{Notes 1, 2, 4} | | | | 0.02 | | μA |
| Watchdog timer operating current | I _{WDT} ^{Notes 1, 2, 5} | f _{IL} = 15 kHz | | | 0.22 | | μA |
| A/D converter operating current | I _{ADC} ^{Notes 1, 6} | When conversion at maximum speed | Normal mode, AV _{REFP} = V _{DD} = 5.0 V | | 1.3 | 1.7 | mA |
| | | | Low voltage mode, AV _{REFP} = V _{DD} = 3.0 V | | 0.5 | 0.7 | mA |
| A/D converter reference voltage current | I _{ADREF} ^{Note 1} | | | | 75.0 | | μA |
| Temperature sensor operating current | I _{TMPS} ^{Note 1} | | | | 75.0 | | μA |
| LVD operating current | I _{LVI} ^{Notes 1, 7} | | | | 0.08 | | μA |
| Self-programming operating current | I _{FSP} ^{Notes 1, 9} | | | | 2.50 | 12.20 | mA |
| BGO operating current | I _{BGO} ^{Notes 1, 8} | | | | 2.50 | 12.20 | mA |
| SNOOZE operating current | I _{SNOZ} ^{Note 1} | ADC operation | The mode is performed ^{Note 10} | | 0.50 | 0.60 | mA |
| | | | The A/D conversion operations are performed, Low voltage mode, AV _{REFP} = V _{DD} = 3.0 V | | 1.20 | 1.44 | mA |
| | | CSI/UART operation | | | 0.70 | 0.84 | mA |

Notes 1. Current flowing to V_{DD}.

- When high speed on-chip oscillator and high-speed system clock are stopped.
- Current flowing only to the real-time clock (RTC) (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either I_{DD1} or I_{DD2}, and I_{RTC}, when the real-time clock operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected, I_{FIL} should be added. I_{DD2} subsystem clock operation includes the operational current of the real-time clock.
- Current flowing only to the 12-bit interval timer (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either I_{DD1} or I_{DD2}, and I_{IT}, when the 12-bit interval timer operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected, I_{FIL} should be added.
- Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The supply current of the RL78 microcontrollers is the sum of I_{DD1}, I_{DD2} or I_{DD3} and I_{WDT} when the watchdog timer is in operation.

AC Timing Test Points**External System Clock Timing****TI/TO Timing****Interrupt Request Input Timing****Key Interrupt Input Timing****RESET Input Timing**

(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)

(T_A = -40 to +85°C, 2.7 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|--|--|--|-----------------------------------|------|---------------------------|------|----------------------------|------|------|
| | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp cycle time | t _{KCY1} | t _{KCY1} ≥ 2/f _{CLK} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | 62.5 | | 250 | | 500 | ns |
| | | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | 83.3 | | 250 | | 500 | ns |
| SCKp high-/low-level width | t _{KH1} , t _{KL1} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | t _{KCY1} /2 – 7 | | t _{KCY1} /2 – 50 | | t _{KCY1} /2 – 50 | | ns |
| | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | t _{KCY1} /2 – 10 | | t _{KCY1} /2 – 50 | | t _{KCY1} /2 – 50 | | ns |
| Slp setup time (to SCKp↑) <small>Note 1</small> | t _{SIK1} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | 23 | | 110 | | 110 | | ns |
| | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | 33 | | 110 | | 110 | | ns |
| Slp hold time (from SCKp↑) <small>Note 2</small> | t _{KSI1} | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | 10 | | 10 | | 10 | | ns |
| Delay time from SCKp↓ to SOp output <small>Note 3</small> | t _{KSO1} | C = 20 pF <small>Note 4</small> | | 10 | | 10 | | 10 | ns |

- Notes**
1. When DAP_{mn} = 0 and CKP_{mn} = 0, or DAP_{mn} = 1 and CKP_{mn} = 1. The Slp setup time becomes “to SCKp↓” when DAP_{mn} = 0 and CKP_{mn} = 1, or DAP_{mn} = 1 and CKP_{mn} = 0.
 2. When DAP_{mn} = 0 and CKP_{mn} = 0, or DAP_{mn} = 1 and CKP_{mn} = 1. The Slp hold time becomes “from SCKp↓” when DAP_{mn} = 0 and CKP_{mn} = 1, or DAP_{mn} = 1 and CKP_{mn} = 0.
 3. When DAP_{mn} = 0 and CKP_{mn} = 0, or DAP_{mn} = 1 and CKP_{mn} = 1. The delay time to SOp output becomes “from SCKp↑” when DAP_{mn} = 0 and CKP_{mn} = 1, or DAP_{mn} = 1 and CKP_{mn} = 0.
 4. C is the load capacitance of the SCKp and SOp output lines.

Caution Select the normal input buffer for the Slp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

- Remarks**
1. This value is valid only when CSI00's peripheral I/O redirect function is not used.
 2. p: CSI number (p = 00), m: Unit number (m = 0), n: Channel number (n = 0),
g: PIM and POM numbers (g = 1)
 3. f_{MCK}: Serial array unit operation clock frequency
(Operation clock to be set by the CKS_{mn} bit of serial mode register mn (SMR_{mn}). m: Unit number,
n: Channel number (mn = 00))

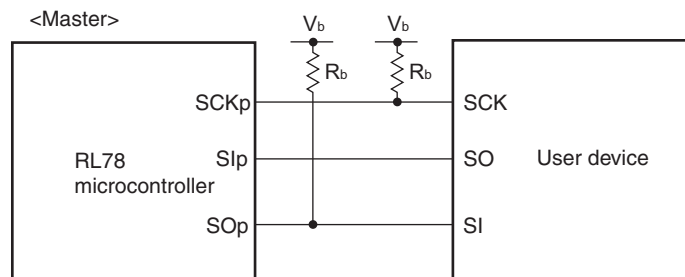
(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output)
(1/3)(T_A = -40 to +85°C, 1.8 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|-----------------------|-------------------|--|----------------------------|------|----------------------------|------|----------------------------|------|------|
| | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp cycle time | t _{KCY1} | t _{KCY1} ≥ 4/f _{CLK} 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 30 pF, R _b = 1.4 kΩ | 300 | | 1150 | | 1150 | | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 30 pF, R _b = 2.7 kΩ | 500 | | 1150 | | 1150 | | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note} , C _b = 30 pF, R _b = 5.5 kΩ | 1150 | | 1150 | | 1150 | | ns |
| SCKp high-level width | t _{KH1} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 30 pF, R _b = 1.4 kΩ | t _{KCY1} /2 – 75 | | t _{KCY1} /2 – 75 | | t _{KCY1} /2 – 75 | | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 30 pF, R _b = 2.7 kΩ | t _{KCY1} /2 – 170 | | t _{KCY1} /2 – 170 | | t _{KCY1} /2 – 170 | | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note} , C _b = 30 pF, R _b = 5.5 kΩ | t _{KCY1} /2 – 458 | | t _{KCY1} /2 – 458 | | t _{KCY1} /2 – 458 | | ns |
| SCKp low-level width | t _{KL1} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 30 pF, R _b = 1.4 kΩ | t _{KCY1} /2 – 12 | | t _{KCY1} /2 – 50 | | t _{KCY1} /2 – 50 | | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 30 pF, R _b = 2.7 kΩ | t _{KCY1} /2 – 18 | | t _{KCY1} /2 – 50 | | t _{KCY1} /2 – 50 | | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note} , C _b = 30 pF, R _b = 5.5 kΩ | t _{KCY1} /2 – 50 | | t _{KCY1} /2 – 50 | | t _{KCY1} /2 – 50 | | ns |

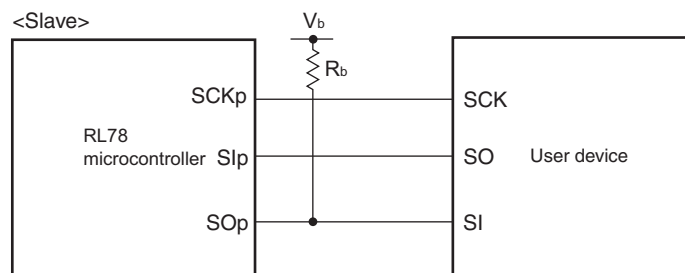
Note Use it with EV_{DD0} ≥ V_b.

Caution Select the TTL input buffer for the SIp pin and the N-ch open drain output (V_{DD} tolerance (When 20- to 52-pin products)/EV_{DD} tolerance (When 64- to 128-pin products)) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V_{IH} and V_{IL}, see the DC characteristics with TTL input buffer selected.

(Remarks are listed two pages after the next page.)

CSI mode connection diagram (during communication at different potential)

- Remarks**
1. $R_b[\Omega]$: Communication line (SCKp, SOp) pull-up resistance, $C_b[F]$: Communication line (SCKp, SOp) load capacitance, $V_b[V]$: Communication line voltage
 2. p: CSI number ($p = 00, 01, 10, 20, 30, 31$), m: Unit number, n: Channel number ($mn = 00, 01, 02, 10, 12, 13$), g: PIM and POM number ($g = 0, 1, 4, 5, 8, 14$)
 3. f_{MCK} : Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
m: Unit number, n: Channel number ($mn = 00$))
 4. CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential.
Use other CSI for communication at different potential.

CSI mode connection diagram (during communication at different potential)

- Remarks**
1. $R_b[\Omega]$: Communication line (SO_p) pull-up resistance, $C_b[F]$: Communication line (SO_p) load capacitance, $V_b[V]$: Communication line voltage
 2. p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)
 3. f_{MCK} : Serial array unit operation clock frequency
(Operation clock to be set by the CKS_{mn} bit of serial mode register mn (SMR_{mn}).
m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13))
 4. CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential.
Use other CSI for communication at different potential.

- Notes**
1. Excludes quantization error ($\pm 1/2$ LSB).
 2. This value is indicated as a ratio (%FSR) to the full-scale value.
 3. When $AV_{REFP} < V_{DD}$, the MAX. values are as follows.
Overall error: Add ± 1.0 LSB to the MAX. value when $AV_{REFP} = V_{DD}$.
Zero-scale error/Full-scale error: Add $\pm 0.05\%$ FSR to the MAX. value when $AV_{REFP} = V_{DD}$.
Integral linearity error/ Differential linearity error: Add ± 0.5 LSB to the MAX. value when $AV_{REFP} = V_{DD}$.
 4. Values when the conversion time is set to $57\ \mu\text{s}$ (min.) and $95\ \mu\text{s}$ (max.).
 5. Refer to **2.6.2 Temperature sensor/internal reference voltage characteristics**.

(4) When reference voltage (+) = Internal reference voltage (ADREFP1 = 1, ADREFP0 = 0), reference voltage (-) = AV_{REFM}/ANI1 (ADREFM = 1), target pin : ANI0, ANI2 to ANI14, ANI16 to ANI26

(T_A = -40 to +85°C, 2.4 V ≤ V_{DD} ≤ 5.5 V, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD}, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V, Reference voltage (+) = V_{BGR}^{Note 3}, Reference voltage (-) = AV_{REFM} = 0 V^{Note 4}, HS (high-speed main) mode)

| Parameter | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|--|-------------------|------------------|---------------------------------|------|------|------------------------------------|------|
| Resolution | RES | | | 8 | | | bit |
| Conversion time | t _{CONV} | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | 17 | | 39 | μs |
| Zero-scale error ^{Notes 1, 2} | E _{zs} | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | | | ±0.60 | %FSR |
| Integral linearity error ^{Note 1} | ILE | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | | | ±2.0 | LSB |
| Differential linearity error ^{Note 1} | DLE | 8-bit resolution | 2.4 V ≤ V _{DD} ≤ 5.5 V | | | ±1.0 | LSB |
| Analog input voltage | V _{AIN} | | | 0 | | V _{BGR} ^{Note 3} | V |

Notes 1. Excludes quantization error (±1/2 LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. Refer to **2.6.2 Temperature sensor/internal reference voltage characteristics**.

4. When reference voltage (-) = V_{SS}, the MAX. values are as follows.

Zero-scale error: Add ±0.35%FSR to the MAX. value when reference voltage (-) = AV_{REFM}.

Integral linearity error: Add ±0.5 LSB to the MAX. value when reference voltage (-) = AV_{REFM}.

Differential linearity error: Add ±0.2 LSB to the MAX. value when reference voltage (-) = AV_{REFM}.

(2) Flash ROM: 96 to 256 KB of 30- to 100-pin products**($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq \text{EV}_{\text{DD}0} = \text{EV}_{\text{DD}1} \leq \text{V}_{\text{DD}} \leq 5.5\text{ V}$, $\text{V}_{\text{SS}} = \text{EV}_{\text{SS}0} = \text{EV}_{\text{SS}1} = 0\text{ V}$) (1/2)**

| Parameter | Symbol | Conditions | | | | | MIN. | TYP. | MAX. | Unit |
|--------------------------|------------------|---------------------------|-------------------------------------|--|------------------|---------------------------------------|------|------|------|---------------|
| Supply current Note 1 | I _{DD1} | Operating mode | HS (high-speed main) mode Note 5 | $f_{\text{IH}} = 32\text{ MHz}$ Note 3 | Basic operation | $\text{V}_{\text{DD}} = 5.0\text{ V}$ | | 2.3 | | mA |
| | | | | | | $\text{V}_{\text{DD}} = 3.0\text{ V}$ | | 2.3 | | mA |
| | | | | | Normal operation | $\text{V}_{\text{DD}} = 5.0\text{ V}$ | | 5.2 | 9.2 | mA |
| | | | | | | $\text{V}_{\text{DD}} = 3.0\text{ V}$ | | 5.2 | 9.2 | mA |
| | | | | $f_{\text{IH}} = 24\text{ MHz}$ Note 3 | Normal operation | $\text{V}_{\text{DD}} = 5.0\text{ V}$ | | 4.1 | 7.0 | mA |
| | | | | | | $\text{V}_{\text{DD}} = 3.0\text{ V}$ | | 4.1 | 7.0 | mA |
| | | | | $f_{\text{IH}} = 16\text{ MHz}$ Note 3 | Normal operation | $\text{V}_{\text{DD}} = 5.0\text{ V}$ | | 3.0 | 5.0 | mA |
| | | | | | | $\text{V}_{\text{DD}} = 3.0\text{ V}$ | | 3.0 | 5.0 | mA |
| | | | HS (high-speed main) mode Note 5 | $f_{\text{MX}} = 20\text{ MHz}$ Note 2, $\text{V}_{\text{DD}} = 5.0\text{ V}$ | Normal operation | Square wave input | | 3.4 | 5.9 | mA |
| | | | | | | Resonator connection | | 3.6 | 6.0 | mA |
| | | | | $f_{\text{MX}} = 20\text{ MHz}$ Note 2, $\text{V}_{\text{DD}} = 3.0\text{ V}$ | Normal operation | Square wave input | | 3.4 | 5.9 | mA |
| | | | | | | Resonator connection | | 3.6 | 6.0 | mA |
| | | | | $f_{\text{MX}} = 10\text{ MHz}$ Note 2, $\text{V}_{\text{DD}} = 5.0\text{ V}$ | Normal operation | Square wave input | | 2.1 | 3.5 | mA |
| | | | | | | Resonator connection | | 2.1 | 3.5 | mA |
| | | | | $f_{\text{MX}} = 10\text{ MHz}$ Note 2, $\text{V}_{\text{DD}} = 3.0\text{ V}$ | Normal operation | Square wave input | | 2.1 | 3.5 | mA |
| | | | | | | Resonator connection | | 2.1 | 3.5 | mA |
| | | Subsystem clock operation | | $f_{\text{SUB}} = 32.768\text{ kHz}$ Note 4 $T_A = -40^\circ\text{C}$ | Normal operation | Square wave input | | 4.8 | 5.9 | μA |
| | | | | | | Resonator connection | | 4.9 | 6.0 | μA |
| | | | | $f_{\text{SUB}} = 32.768\text{ kHz}$ Note 4 $T_A = +25^\circ\text{C}$ | Normal operation | Square wave input | | 4.9 | 5.9 | μA |
| | | | | | | Resonator connection | | 5.0 | 6.0 | μA |
| | | | | $f_{\text{SUB}} = 32.768\text{ kHz}$ Note 4 $T_A = +50^\circ\text{C}$ | Normal operation | Square wave input | | 5.0 | 7.6 | μA |
| | | | | | | Resonator connection | | 5.1 | 7.7 | μA |
| | | | | $f_{\text{SUB}} = 32.768\text{ kHz}$ Note 4 $T_A = +70^\circ\text{C}$ | Normal operation | Square wave input | | 5.2 | 9.3 | μA |
| | | | | | | Resonator connection | | 5.3 | 9.4 | μA |
| | | | | $f_{\text{SUB}} = 32.768\text{ kHz}$ Note 4 $T_A = +85^\circ\text{C}$ | Normal operation | Square wave input | | 5.7 | 13.3 | μA |
| | | | | | | Resonator connection | | 5.8 | 13.4 | μA |
| | | | | $f_{\text{SUB}} = 32.768\text{ kHz}$ Note 4 $T_A = +105^\circ\text{C}$ | Normal operation | Square wave input | | 10.0 | 46.0 | μA |
| | | | | | | Resonator connection | | 10.0 | 46.0 | μA |

(Notes and Remarks are listed on the next page.)

3.6 Analog Characteristics

3.6.1 A/D converter characteristics

Classification of A/D converter characteristics

| Input channel | Reference Voltage | | |
|--|--|--|--|
| | Reference voltage (+) = AV_{REFP} Reference voltage (-) = AV_{REFM} | Reference voltage (+) = V_{DD} Reference voltage (-) = V_{SS} | Reference voltage (+) = V_{BGR} Reference voltage (-) = AV_{REFM} |
| ANI0 to ANI14 | Refer to 3.6.1 (1). | Refer to 3.6.1 (3). | Refer to 3.6.1 (4). |
| ANI16 to ANI26 | Refer to 3.6.1 (2). | | |
| Internal reference voltage Temperature sensor output voltage | Refer to 3.6.1 (1). | | — |

(1) When reference voltage (+) = $AV_{REFP}/ANI0$ ($ADREFP1 = 0$, $ADREFP0 = 1$), reference voltage (-) = $AV_{REFM}/ANI1$ ($ADREFM = 1$), target pin : ANI2 to ANI14, internal reference voltage, and temperature sensor output voltage

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq AV_{REFP} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = 0\text{ V}$, Reference voltage (+) = AV_{REFP} , Reference voltage (-) = $AV_{REFM} = 0\text{ V}$)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|--|------------|---|---|--------|-------------|---------------|
| Resolution | RES | | 8 | | 10 | bit |
| Overall error ^{Note 1} | AINL | 10-bit resolution $AV_{REFP} = V_{DD}$ ^{Note 3} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | 1.2 | ± 3.5 | LSB |
| Conversion time | t_{CONV} | 10-bit resolution Target pin: ANI2 to ANI14 | $3.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 2.125 | 39 | μs |
| | | | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 3.1875 | 39 | μs |
| | | | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 17 | 39 | μs |
| | | 10-bit resolution Target pin: Internal reference voltage, and temperature sensor output voltage (HS (high-speed main) mode) | $3.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 2.375 | 39 | μs |
| | | | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 3.5625 | 39 | μs |
| | | | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 17 | 39 | μs |
| Zero-scale error ^{Notes 1, 2} | E_{ZS} | 10-bit resolution $AV_{REFP} = V_{DD}$ ^{Note 3} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 0.25 | %FSR |
| Full-scale error ^{Notes 1, 2} | E_{FS} | 10-bit resolution $AV_{REFP} = V_{DD}$ ^{Note 3} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 0.25 | %FSR |
| Integral linearity error ^{Note 1} | ILE | 10-bit resolution $AV_{REFP} = V_{DD}$ ^{Note 3} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 2.5 | LSB |
| Differential linearity error ^{Note 1} | DLE | 10-bit resolution $AV_{REFP} = V_{DD}$ ^{Note 3} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 1.5 | LSB |
| Analog input voltage | V_{AIN} | ANI2 to ANI14 | 0 | | AV_{REFP} | V |
| | | Internal reference voltage output ($2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, HS (high-speed main) mode) | V_{BGR} ^{Note 4} | | | V |
| | | Temperature sensor output voltage ($2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, HS (high-speed main) mode) | V_{TMPS25} ^{Note 4} | | | V |

(Notes are listed on the next page.)

- (4) When reference voltage (+) = Internal reference voltage (ADREFP1 = 1, ADREFP0 = 0), reference voltage (–) = $AV_{REFM}/ANI1$ (ADREFM = 1), target pin : ANI0, ANI2 to ANI14, ANI16 to ANI26

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = EV_{SS0} = EV_{SS1} = 0\text{ V}$, Reference voltage (+) = V_{BGR} ^{Note 3}, Reference voltage (–) = AV_{REFM} ^{Note 4} = 0 V, HS (high-speed main) mode)

| Parameter | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|--|-----------------|------------------|--|------|------|-----------------------------|---------------|
| Resolution | RES | | | 8 | | | bit |
| Conversion time | t_{CONV} | 8-bit resolution | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 17 | | 39 | μs |
| Zero-scale error ^{Notes 1, 2} | E _{ZS} | 8-bit resolution | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | | | ± 0.60 | %FSR |
| Integral linearity error ^{Note 1} | ILE | 8-bit resolution | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | | | ± 2.0 | LSB |
| Differential linearity error ^{Note 1} | DLE | 8-bit resolution | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | | | ± 1.0 | LSB |
| Analog input voltage | V_{AIN} | | | 0 | | V_{BGR} ^{Note 3} | V |

Notes 1. Excludes quantization error ($\pm 1/2$ LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. Refer to **3.6.2 Temperature sensor/internal reference voltage characteristics**.

4. When reference voltage (–) = V_{SS} , the MAX. values are as follows.

Zero-scale error: Add $\pm 0.35\%$ FSR to the MAX. value when reference voltage (–) = AV_{REFM} .

Integral linearity error: Add ± 0.5 LSB to the MAX. value when reference voltage (–) = AV_{REFM} .

Differential linearity error: Add ± 0.2 LSB to the MAX. value when reference voltage (–) = AV_{REFM} .

3.6.2 Temperature sensor/internal reference voltage characteristics

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = 0\text{ V}$, HS (high-speed main) mode)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|-----------------------------------|--------------|---|------|------|------|----------------------|
| Temperature sensor output voltage | V_{TMPS25} | Setting ADS register = 80H, $T_A = +25^\circ\text{C}$ | | 1.05 | | V |
| Internal reference voltage | V_{BGR} | Setting ADS register = 81H | 1.38 | 1.45 | 1.5 | V |
| Temperature coefficient | F_{VTMPS} | Temperature sensor that depends on the temperature | | –3.6 | | mV/ $^\circ\text{C}$ |
| Operation stabilization wait time | t_{AMP} | | 5 | | | μs |

| Rev. | Date | Description | |
|------|--------------|-------------|--|
| | | Page | Summary |
| 3.00 | Aug 02, 2013 | 118 | Modification of table in 2.6.2 Temperature sensor/internal reference voltage characteristics |
| | | 118 | Modification of table and note in 2.6.3 POR circuit characteristics |
| | | 119 | Modification of table in 2.6.4 LVD circuit characteristics |
| | | 120 | Modification of table of LVD Detection Voltage of Interrupt & Reset Mode |
| | | 120 | Renamed to 2.6.5 Power supply voltage rising slope characteristics |
| | | 122 | Modification of table, figure, and remark in 2.10 Timing Specs for Switching Flash Memory Programming Modes |
| | | 123 | Modification of caution 1 and description |
| | | 124 | Modification of table and remark 3 in Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$) |
| | | 126 | Modification of table, note, caution, and remark in 3.2.1 X1, XT1 oscillator characteristics |
| | | 126 | Modification of table in 3.2.2 On-chip oscillator characteristics |
| | | 127 | Modification of note 3 in 3.3.1 Pin characteristics (1/5) |
| | | 128 | Modification of note 3 in 3.3.1 Pin characteristics (2/5) |
| | | 133 | Modification of notes 1 and 4 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (1/2) |
| | | 135 | Modification of notes 1, 5, and 6 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (2/2) |
| | | 137 | Modification of notes 1 and 4 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (1/2) |
| | | 139 | Modification of notes 1, 5, and 6 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (2/2) |
| | | 140 | Modification of (3) Peripheral Functions (Common to all products) |
| | | 142 | Modification of table in 3.4 AC Characteristics |
| | | 143 | Addition of Minimum Instruction Execution Time during Main System Clock Operation |
| | | 143 | Modification of figure of AC Timing Test Points |
| | | 143 | Modification of figure of External System Clock Timing |
| | | 145 | Modification of figure of AC Timing Test Points |
| | | 145 | Modification of description, note 1, and caution in (1) During communication at same potential (UART mode) |
| | | 146 | Modification of description in (2) During communication at same potential (CSI mode) |
| | | 147 | Modification of description in (3) During communication at same potential (CSI mode) |
| | | 149 | Modification of table, note 1, and caution in (4) During communication at same potential (simplified I ² C mode) |
| | | 151 | Modification of table, note 1, and caution in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2) |
| | | 152 to 154 | Modification of table, notes 2 to 6, caution, and remarks 1 to 4 in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (2/2) |
| | | 155 | Modification of table in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (1/3) |
| | | 156 | Modification of table and caution in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (2/3) |
| | | 157, 158 | Modification of table, caution, and remarks 3 and 4 in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (3/3) |
| | | 160, 161 | Modification of table and caution in (7) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) |